# Old Company Name in Catalogs and Other Documents

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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# 2SK2925(L),2SK2925(S)

# Silicon N Channel MOS FET High Speed Power Switching

REJ03G1039-0500

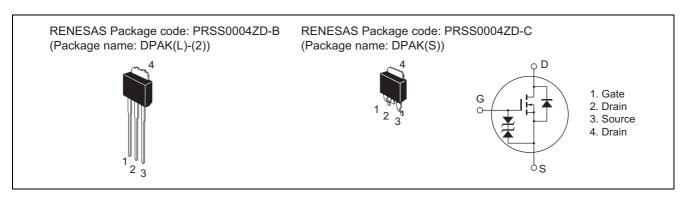
(Previous: ADE-208-454B)

Rev.5.00 Sep 07, 2005

### **Features**

- Low on-resistance  $R_{DS} = 0.060 \Omega$  typ.
- High speed switching
- 4 V gate drive device can be driven from 5 V source

#### **Outline**



# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	60	V
Gate to source voltage	$V_{GSS}$	±20	V
Drain current	I <sub>D</sub>	10	A
Drain peak current	I <sub>D(pulse)</sub> Note1	40	A
Body-drain diode reverse drain current	I <sub>DR</sub>	10	Α
Avalanche current	I <sub>AP</sub> Note3	10	Α
Avalanche energy	E <sub>AR</sub> Note3	8.5	mJ
Channel dissipation	Pch Note2	20	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1 %

2. Value at  $Tc = 25^{\circ}C$ 

3. Value at Tch = 25°C, Rg  $\geq$  50  $\Omega$ 

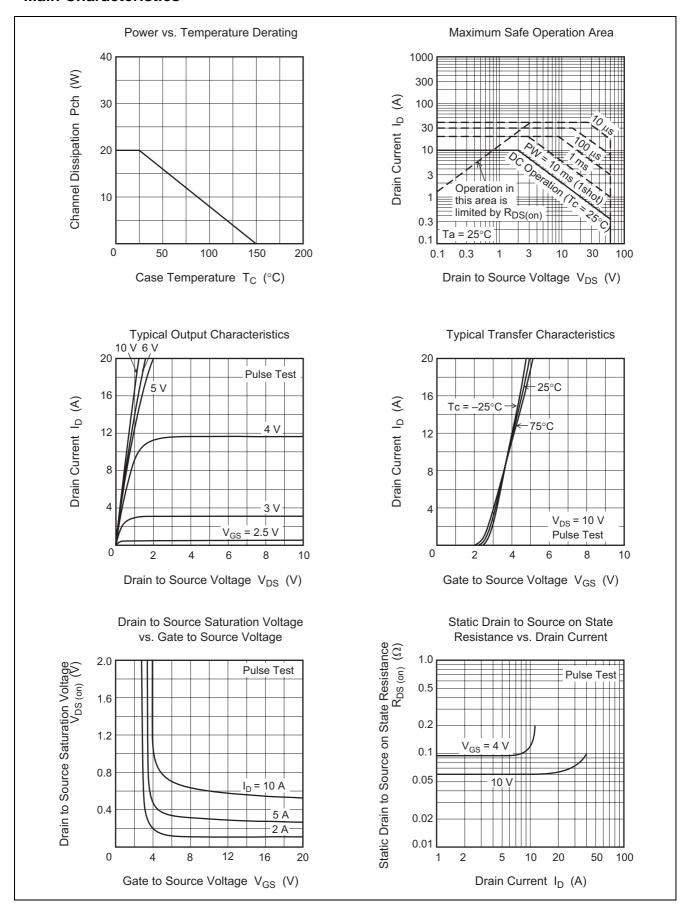
## **Electrical Characteristics**

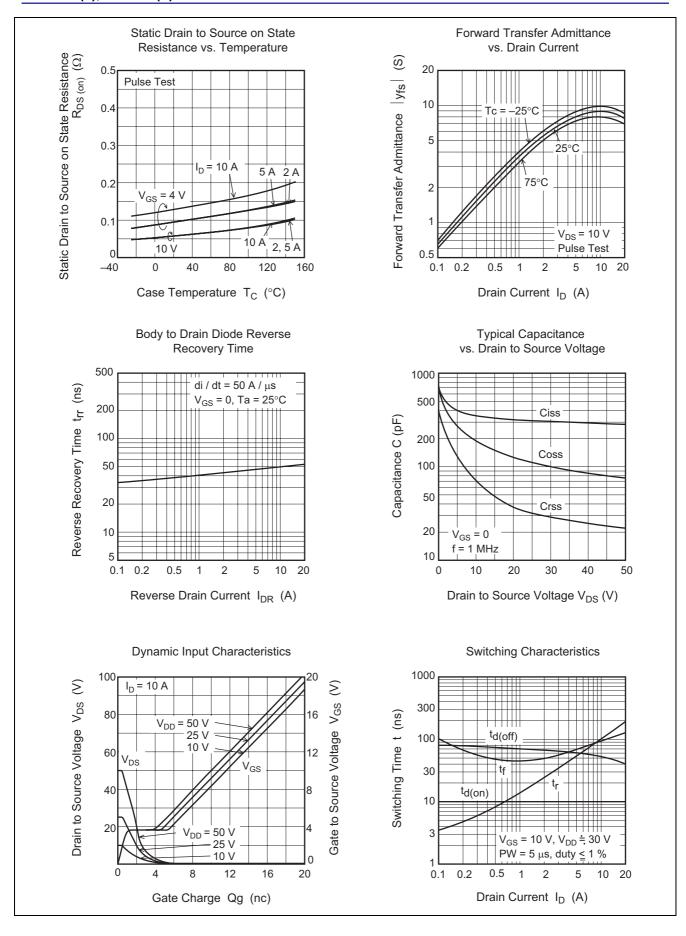
 $(Ta = 25^{\circ}C)$ 

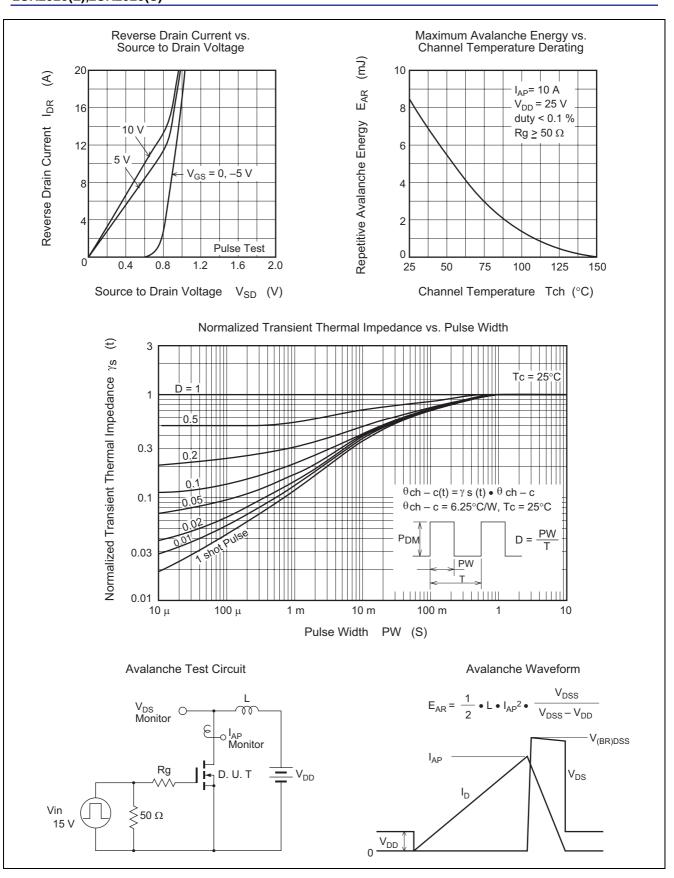
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	10	μΑ	$V_{DS} = 60 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V <sub>GS(off)</sub>	1.5	_	2.5	V	I <sub>D</sub> = 1 mA, V <sub>DS</sub> = 10 V
Static drain to source on state	R <sub>DS(on)</sub>	_	0.060	0.080	Ω	$I_D = 5 A$ , $V_{GS} = 10 V^{Note4}$
resistance	R <sub>DS(on)</sub>	_	0.095	0.160	Ω	$I_D = 5 A$ , $V_{GS} = 4 V$ Note4
Forward transfer admittance	y <sub>fs</sub>	5	8	_	S	$I_D = 5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	350	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	190	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	70	_	pF	
Turn-on delay time	t <sub>d(on)</sub>	_	10	_	ns	I <sub>D</sub> = 5 A, V <sub>GS</sub> = 10 V,
Rise time	t <sub>r</sub>	_	55	_	ns	$R_L = 6 \Omega$
Turn-off delay time	t <sub>d(off)</sub>	_	60	_	ns	
Fall time	t <sub>f</sub>	_	70	_	ns	
Body-drain diode forward voltage	$V_{DF}$	_	0.9	_	V	I <sub>F</sub> = 10 A, V <sub>GS</sub> = 0
Body-drain diode reverse recovery time	t <sub>rr</sub>	_	50	_	ns	$I_F = 10 \text{ A}, V_{GS} = 0,$ diF/ dt =50A/ $\mu$ s

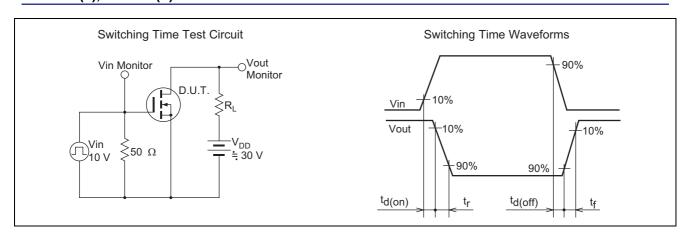
Note: 4. Pulse test

#### **Main Characteristics**

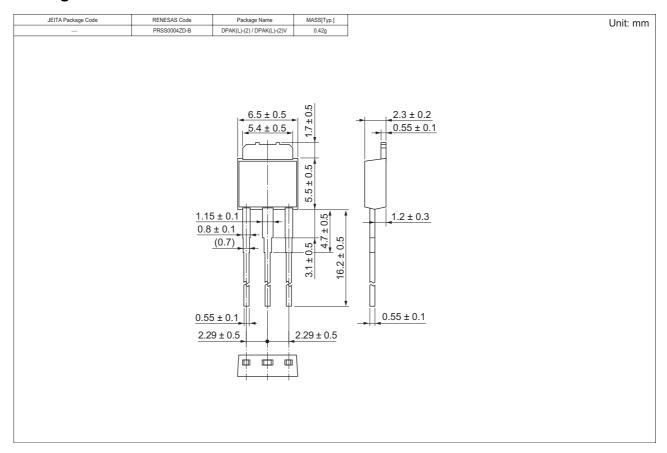


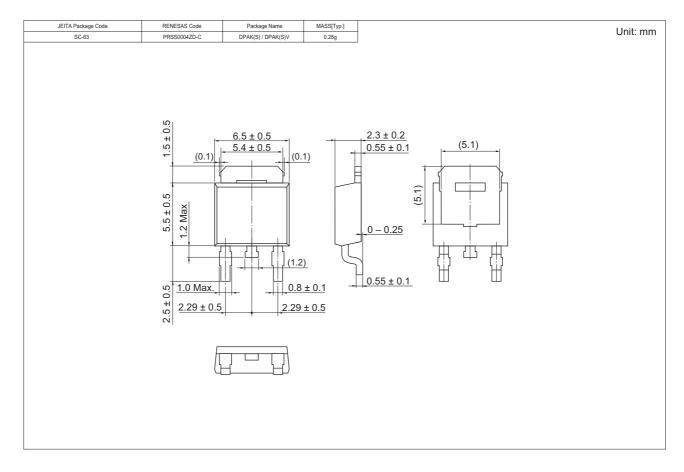






# **Package Dimensions**





# **Ordering Information**

Part Name	Quantity	Shipping Container
2SK2925L-E	3200 pcs	Box (Sack)
2SK292ST5L-E	3000 pcs	Taping

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